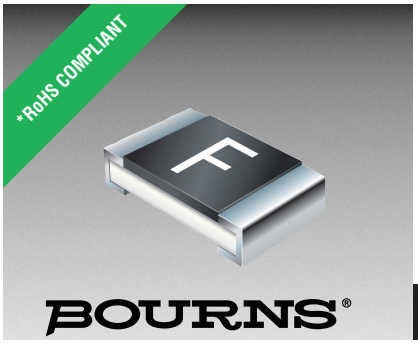


SingIFuse™ SF-0603FP Series Features

- Fast acting precision thin film chip fuse for overcurrent protection
- 1608 (EIA 0603) miniature footprint
- Surface mount packaging for automated assembly
- UL listed (UL 248-14)
- RoHS compliant* and halogen free**

SF-0603FP Series - Fast Acting Precision Surface Mount Fuses

Electrical Characteristics

Model	Rated Current (Amps)	Fusing Time	Resistance Tolerance ±25 % (mΩ) ***	Rated Voltage	Breaking Capacity	Typical I^2t (A^2s) ****
SF-0603FP050	0.50	Open within 5 sec. at 200 % rated current	260	DC 50 V	DC 50 V 50 A	0.088
SF-0603FP063	0.63		218	DC 32 V	DC 32 V 50 A	0.0125
SF-0603FP080	0.80		132			0.0206
SF-0603FP100	1.00		84.5			0.0211
SF-0603FP125	1.25		63			0.0472
SF-0603FP150	1.50		50.5			0.0623
SF-0603FP160	1.60		46			0.0817
SF-0603FP200	2.00		32			0.1176
SF-0603FP250	2.50		25.5			0.1807
SF-0603FP300	3.00		20			0.3177
SF-0603FP315	3.15		19			0.3615
SF-0603FP400	4.00		13			0.5348
SF-0603FP500	5.00		10			0.7726

*** Resistance value measured with less than 10 % of rated current. Tolerance ±25 %.
****Typical I^2t value measured at 10x rated current.

Reliability Testing

Parameter	Requirement	Test Method
Carrying Capacity	No fusing	Rated current, 4 hours
Fusing Time	Within 5 seconds	200 % of its rated current
Interrupting Ability	No mechanical damages	After the fuse is interrupted, rated voltage applied for 30 seconds again
Bending Test	No mechanical damages	Distance between holding points: 90 mm, Bending: 3 mm,1time, 30 seconds
Resistance to Solder Heat	±20 %	260 °C ±5 °C,10 seconds ±1 second
Solderability	95 % coverage minimum	235 °C ±5 °C, 2 ±0.5 second 245 °C ±5 °C, 2 ±0.5 second (lead free)
Temperature Rise	<75 ° C	100 % of its rated current, measure of surface temperature
Resistance to Dry Heat	±20 %	105 °C ±5 °C,1000 hours
Resistance to Solvent	No evident damage on protective coating and marking	23 °C ±5 °C of isopropyl alcohol, 90 seconds
Residual Resistance	10k ohms or more	Measure DC resistance after fusing
Thermal Shock	ΔR < 10 %	-20 °C / +25 °C /+125 °C /+25 °C, 10 cycles

UL File Number E198545
http://www.ul.com/ Follow link to Online Certificates Directory, then enter UL File No. E198545, or click here

Environmental Characteristics

Operating Temperature ..... -20 °C to +105 °C
Storage Conditions
- Temperature ..... +5 °C to +35 °C
- Humidity ..... 40 % to 75 %
- Shelf Life ..... 2 years from manufacturing date

Moisture Sensitivity Level 1
ESD Classification (HBM) ..... Class 6

BOURNS®

Asia-Pacific:
Tel: +886-2 2562-4117
Email: asiacus@bourns.com

Europe:
Tel: +36 88 520 390
Email: eurocus@bourns.com

The Americas:
Tel: +1-951 781-5500
Email: americus@bourns.com

www.bourns.com

* RoHS Directive 2015/863, Mar 31, 2015 and Annex.
**Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less.

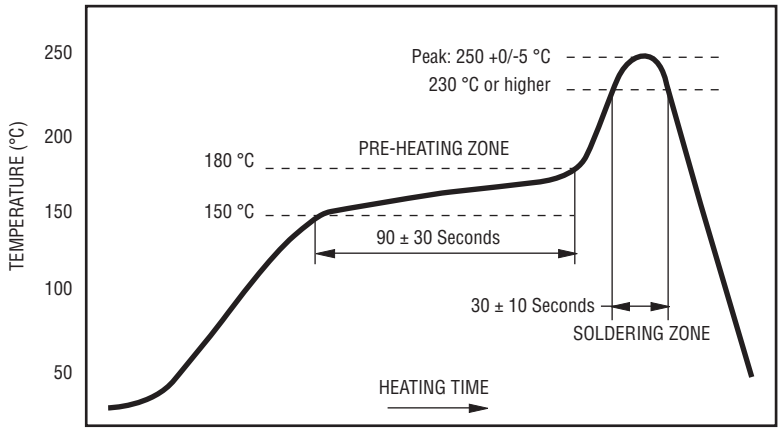
SingIFuse™ SF-0603FP Series Applications

- Portable memory
- LCD monitors
- Disk drives
- PDAs
- Digital cameras
- DVDs
- Cell phones
- Rechargeable battery packs
- Battery chargers
- Set top boxes
- Industrial controllers

SF-0603FP Series - Fast Acting Precision Surface Mount Fuses

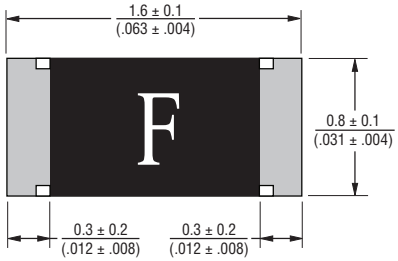
BOURNS®

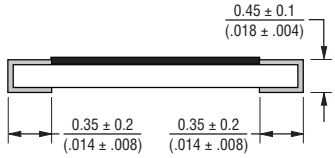
Solder Reflow Recommendations



PEAK: 250 +0/-5 °C, 5 seconds
PRE-HEATING ZONE: 150 to 180 °C, 90 ± 30 seconds
SOLDERING ZONE: 230 °C or higher, 30 ± 10 seconds

Product Dimensions

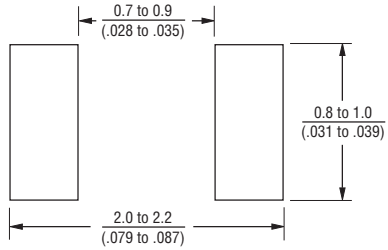




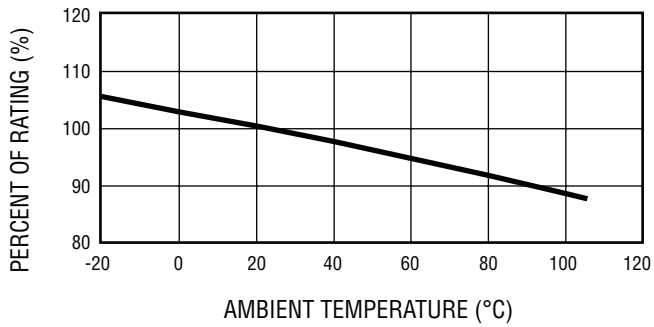
DIMENSIONS: MM / (INCHES)

PACKAGING: 5,000 pcs./reel

Recommended Pad Layout



Thermal Derating Curve



Construction & Material Content